



SAMSUNG ELECTRONICS AMERICA, INC.
American QA Lab
19 Chapin Rd. Building D
Pine Brook, NJ 07058

Date: **June 19, 2015**

FCC ID: A3LSMA800YZ

We attest that

@ Test Case : HSDPA / HSUPA Average power check.

@ Reviewer's Comment

HSDPA : Subset 3/4 are mostly higher than the tune up power with MPR.

HSUPA : Subset 2/4 mostly higher than the tune up power with MPR

@ Developer's opinion.

"This each case's powers are satisfy 3GPP power spec. some subset power didn't meet MPR in lab test, but we want to progress with measured value."

Sincerely,

A handwritten signature in black ink, appearing to be "Seokung Hong", written over a light gray rectangular background.

Seokung Hong

Assistant Engineer

Samsung Electronics CO. LTD

E-mail: seogung.hong@samsung.com